Translation

PATENT COOPERATION TREATY



PCT

511,855

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference I0352WO/MGL	FOR FURTHER ACTION See Notification of Transmittal of International Preliminary Examination Report (Form PCT/IPEA/416)							
International application No.	International filing date (day/month/	year) Priority date (day/month/year)						
PCT/DE2003/001171	09 April 2003 (09.04.200	3) 19 April 2002 (19.04.2002)						
International Patent Classification (IPC) or national classification and IPC H01L 23/522								
Applicant INFINEON TECHNOLOGIES AG								
 This international preliminary examination report has been prepared by this International Preliminary Examining Authority and is transmitted to the applicant according to Article 36. 								
2. This REPORT consists of a total of	5 sheets, including this	cover sheet.						
This report is also accompanied by ANNEXES, i.e., sheets of the description, claims and/or drawings which have been amended and are the basis for this report and/or sheets containing rectifications made before this Authority (see Rule 70.16 and Section 607 of the Administrative Instructions under the PCT). These annexes consist of a total of3 sheets.								
This report contains indications relating to the following items:								
Basis of the report	* The state of the							
- 🖂 -								
·- L								
		contive step and industrial appreadinty						
Reasoned statemen	Penganad atatament under Article 25/2) with record to world it.							
F-1	Control of the second of the s							
VII Certain defects in the	he international application							
VIII Certain observations on the international application								
Date of submission of the demand	Date of comp	Date of completion of this report						
20 October 2003 (20.10.	2003)	08 October 2004 (08.10.2004)						
Name and mailing address of the IPEA/EP	Authorized o	Authorized officer						
Facsimile No.	Telephone N	о.						

Form PCT/IPEA/409 (cover sheet) (January 1994)

International application No.

PCT/DE2003/001171

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

					FC1/DE2003/001171			
I. Basis of the report								
1. This report has been drawn on the basis of (Replacement sheets which have been furnished to the receiving Office in response to an invitation under Article 14 are referred to in this report as "originally filed" and are not annexed to the report since they do not contain amendments.):								
	the international	al application as originally filed.						
\boxtimes	the description,	pages	1-12	, as originally filed,				
		pages		_, filed with the demand,				
		pages		, filed with the letter of	,			
		pages		, filed with the letter of	· ·			
\boxtimes	the claims,	Nos		, as originally filed,				
		Nos.		, as amended under Article 19,				
		Nos		, filed with the demand,				
		Nos	1-8	, filed with the letter of	24 September 2004 (24.09.2004) ,			
		Nos		, filed with the letter of	··			
	the drawings,	sheets/fig	1/3-3/3	, as originally filed,				
		sheets/fig		, filed with the demand,				
		sheets/fig		, filed with the letter of				
		sheets/fig		, filed with the letter of	·			
2. The amend	lments have result	ed in the cance	ellation of:					
	the description,	pages		-	•			
	the claims,	Nos.		_				
	the drawings,	sheets/fig		- -				
3. Thi to g	s report has been e to beyond the discl	stablished as if losure as filed,	f (some of) the a as indicated in t	mendments had not been ma he Supplemental Box (Rule	ide, since they have been considered 70.2(c)).			
4. Additiona	l observations, if n	ecessary:						
ı								
:								

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International application No.
PCT/DE 03/01171

V. Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement

1.	Statement			
	Novelty (N)	Claims	1-8	YES
		Claims	-	NO
	Inventive step (IS)	Claims	1-8	YES
		Claims	-	NO ·
	Industrial applicability (IA)	Claims	1-8	YES
		Claims		NO

2. Citations and explanations

1. Reference is made to the following documents:

D1: APARICIO R ET AL: 'Capacity limits and matching properties of integrated capacitors' PROCEEDINGS OF THE IEEE 2001 CUSTOM INTEGRATED CIRCUITS CONFERENCE, SAN DIEGO, CA, USA, 6-9 MAY 2001, Vol. 37, No. 3, pages 384-393, IEEE Journal of Solid-State Circuits, March 2002, IEEE, USA

D2: DE-A1-100 19 839 (MURATA MFG. CO. LTD.)
21 June 2001.

2. Document D1 discloses (the references in parentheses are to D1):

a capacitor structure provided with a latticed region (vertical unhatched regions in the right-hand component figure of figure 9b and, in the left-hand component figure, the upper halves of the unhatched lattice in the right-hand component figure) which extends in a plane parallel to the substrate surface and in the recesses of which additional electrically conductive regions are located (figure 9b). That metallic region has surfaces which delimit it above and below in each of its partial regions. It would appear from the intended use in a semiconductor component that the latticed region and the conductive regions in the recesses

INTERNATIONAL PRELIMINARY EXAMINATION REPORT

thereof are each connected to a connecting lead and must be separated from one another by means of insulating layers.

- 2.1 The subject matter of claim 1 differs from that capacitor structure in that said metallic region is continuous in said plane. (The vertical unhatched regions in the right-hand component figure of figure 9b and, in the left-hand component figure, the upper halves of the unhatched lattice in the right-hand component figure form parallel lattice rods which are connected to one another but not in the plane in which the lattice rods are located.) The subject matter of claim 1 is therefore novel in relation to D1.
- 2.2 Since said latticed region, including the metallic regions located in the recesses thereof, lies in a plane, fewer process steps are necessary in order to produce it: at least three planes have to be structured to produce a structure as per D1, but only two to produce the structure claimed in the present application. This simplified process engineering is not suggested by the prior art. The subject matter of claim 1 is therefore inventive.
- 3. Document D2 discloses (the references in parentheses are to D2) a capacitor structure provided with a latticed metallic region (14, figure 1A) which extends in a plane parallel to the substrate surface and in the recesses of which electrically conductive regions are located (21, figure 1A).
- 3.1 The subject matter of claim 1 differs from that capacitor structure in that the electrically conductive regions in the recesses are metallic plates or nodes. The subject matter of claim 1 is therefore novel in relation to D2.
- 3.2 As a result of this difference, the capacitance of the structure is increased. This is not suggested by D1, because D1 addresses a different problem (namely,



International application No. PCT/DE 03/01171

minimization of the inductance). The subject matter of claim 1 is therefore also inventive.

4. Claims 2-8, being dependent claims, are likewise novel and inventive.